## AS A BELOW NAMED INVENTOR, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name.

I believe that I am the original, first and sole (if only one name is listed below), or an original, first and joint inventor (if plural names are listed below), of the subject matter which is claimed and for which a patent is sought on the invention entitled:

## SEMICONDUCTOR DEVICE HAVING A TRENCH ISOLATION STRUCTURE TITLE: AND METHOD FOR FABRICATING THE SAME

United States provisional applicate below and, insofar as the subject or PCT International application the duty to disclose information in	it under Title 35, U.S. Code, §120 of tion(s), or §365(c) of any PCT Internate matter of each of the claims of this a s) in the manner provided by the first paraterial to patentability as defined in the filing date of the prior application (Filing Date)	tional application designating the Upplication is not disclosed in the paragraph of Title 35, U.S. Code, §1 Title 37, The Code of Federal Reg	United State orior United 12, I ackreulations, ional filin	es, listed ed States nowledge §1.56(a) g date of
United States provisional applicate below and, insofar as the subject or PCT International application the duty to disclose information which became available between	tion(s), or §365(c) of any PCT Internate matter of each of the claims of this a s) in the manner provided by the first paraterial to patentability as defined in	tional application designating the Upplication is not disclosed in the paragraph of Title 35, U.S. Code, §1 Title 37, The Code of Federal Reg	Inited Stat prior United 12, I ackr gulations,	es, listed ed States nowledge §1.56(a)
I hereby claim the henef	it under Title 35 II S Code \$120 of	Fany United States application(s)	or 8119(e	e) of any
(Application Number)	(Country)	(Day/Month/Year filed,	,	
71 P. C. N. L.			Yes [ ]	No [ ]
(Application Number)	(Country)	(Day/Month/Year filed,		. ,
2001-15149	Korea	23 March 2001	Priority (Yes [X]	
having a filing date before that o	f the application on which priority is o		Duionite (	Tlaimad.
	w and have also identified below any for		ventor's c	ertificate
•	, or §365(a) of any PCT international a			
•	nation of this application in accordance or this application in accordance or the state of the same of			
claims, as amended by any amended	reviewed and understand the contents dment referred to above. I acknowled	ge the duty to disclose information	n which is	material
•	ded on			·,
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		i assigned Serial No		,
was filed in the U.S. Patent &	& Trademark Office on and	1 ' 10 ' 131		

Reg. No. 40,513; FRANK V. DeROSA, Reg. No. 43,584; GASPARE J. RANDAZZO, Reg. No. 41,528; SUSAN PAIK, Reg. No. 46,347; and JUAN C. VILLAR, Reg. No. 34,271; each of them of F. CHAU & ASSOCIATES, LLP, 1900 Hempstead Turnpike, Suite 501, East Meadow, New York 11554 to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith and with any divisional, continuation, continuation-in-part, reissue or re-examination application, with full power of appointment and with full power to substitute an associate attorney or agent, and to receive all patents which may issue thereon, and request that all correspondence be addressed to:

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I HEREBY DECLARE that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under §1001 of Title 18 U.S. Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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FULL NAME OF SECOND INVENTOR:		Citizenship
Inventor's signature:		Date:
FULL NAME OF THIRD INVENTOR:		Citizenship
Inventor's signature:	Date:	
residence & rost Office Address.		